1/1

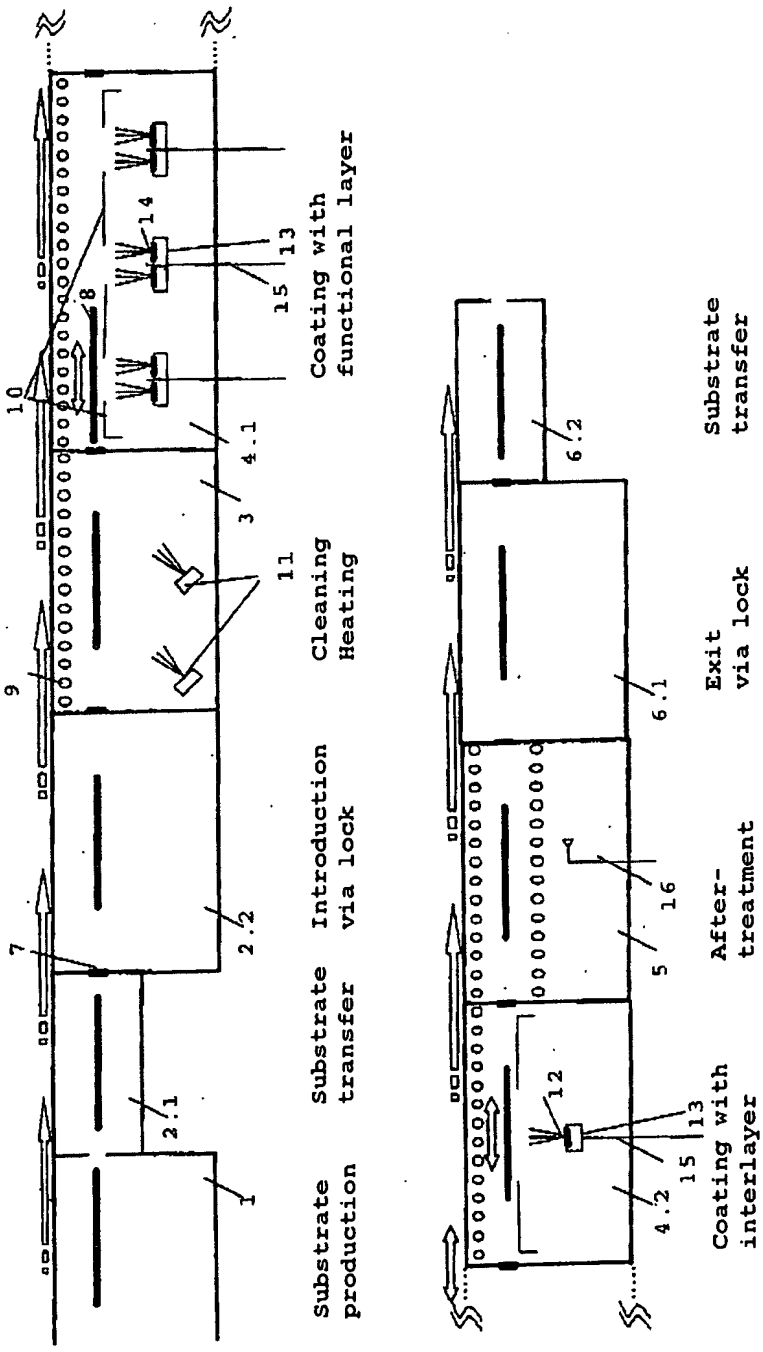
Substrate production
Substrate transfer
Introduction via lock
Cleaning Heating
Coating with functional layer
Coating with interlayer
After-treatment
Exit via lock
Substrate transfer
1
2.1
2.2
3
4.1
4.2
5
6.1
6.2
7
8
9
10
11
12
13
14
15
16

Figure 1